

V <sub>CES</sub>	650V
I <sub>C(100°C)</sub>	15A
V <sub>CE(sat) (Typ.)</sub>	1.65V
P <sub>D</sub>	133W

#### Features

- 1) Low Collector Emitter Saturation Voltage
- 2) Low Switching Loss
- 3) Short Circuit Withstand Time 5µs
- 4) Built in Very Fast & Soft Recovery FRD (RFN - Series)
- 5) Pb free Lead Plating ; RoHS Compliant

#### Applications

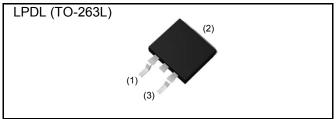
**General Inverter** 

UPS

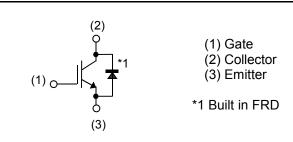
**Power Conditioner** 

Welder

#### Outline



#### Inner Circuit



#### Packaging Specifications

Туре	Packaging	Taping
	Reel Size (mm)	330
	Tape Width (mm)	24
	Basic Ordering Unit (pcs)	1,000
	Packing Code	TL
	Marking	RGT30NL65D

#### •Absolute Maximum Ratings (at T<sub>C</sub> = 25°C unless otherwise specified)

Parameter		Symbol	Value	Unit
Collector - Emitter Voltage		V <sub>CES</sub>	650	V
Gate - Emitter Voltage		V <sub>GES</sub>	±30	V
Callester Current	T <sub>C</sub> = 25°C	Ι <sub>C</sub>	30	А
Collector Current	T <sub>C</sub> = 100°C	Ι <sub>C</sub>	15	А
Pulsed Collector Current		I <sub>CP</sub> *1	45	А
Diode Forward Current	T <sub>C</sub> = 25°C	١ <sub>F</sub>	26	А
	T <sub>C</sub> = 100°C	I <sub>F</sub>	15	А
Diode Pulsed Forward Current		I <sub>FP</sub> <sup>*1</sup>	45	А
Power Discinction	T <sub>C</sub> = 25°C	P <sub>D</sub>	133	W
Power Dissipation	T <sub>C</sub> = 100°C	P <sub>D</sub>	66	W
Operating Junction Temperature		Tj	-40 to +175	°C
Storage Temperature		T <sub>stg</sub>	–55 to +175	°C
*1 Dulco width limitod by T				

\*1 Pulse width limited by T<sub>jmax.</sub>

#### Thermal Resistance

Parameter	Symbol	Values			Unit
Faranieter	Symbol	Min.	Тур.	Max.	Offic
Thermal Resistance IGBT Junction - Case	$R_{\theta(j\text{-}c)}$	-	-	1.12	°C/W
Thermal Resistance Diode Junction - Case	$R_{\theta(j\text{-}c)}$	-	-	2.86	°C/W

### ●IGBT Electrical Characteristics (at T<sub>j</sub> = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit	
Faranieler	Parameter Symbol Conditions		Min.	Тур.	Max.	Unit	
Collector - Emitter Breakdown Voltage	BV <sub>CES</sub>	I <sub>C</sub> = 10μΑ, V <sub>GE</sub> = 0V	650	-	-	V	
Collector Cut - off Current	I <sub>CES</sub>	V <sub>CE</sub> = 650V, V <sub>GE</sub> = 0V	-	-	10	μA	
Gate - Emitter Leakage Current	I <sub>GES</sub>	$V_{GE}$ = ±30V, $V_{CE}$ = 0V	-	-	±200	nA	
Gate - Emitter Threshold Voltage	V <sub>GE(th)</sub>	V <sub>CE</sub> = 5V, I <sub>C</sub> = 10.0mA	5.0	6.0	7.0	V	
Collector - Emitter Saturation Voltage	V <sub>CE(sat)</sub>	$I_{c} = 15A, V_{GE} = 15V$ $T_{j} = 25^{\circ}C$ $T_{j} = 175^{\circ}C$	-	1.65 2.15	2.1	V	

## •IGBT Electrical Characteristics (at $T_j = 25^{\circ}C$ unless otherwise specified)

Deremeter	Curren el	Conditions -	Values			11
Parameter	Symbol		Min.	Тур.	Max.	Unit
Input Capacitance	C <sub>ies</sub>	V <sub>CE</sub> = 30V	-	780	-	
Output Capacitance	C <sub>oes</sub>	V <sub>GE</sub> = 0V	-	35	-	pF
Reverse Transfer Capacitance	C <sub>res</sub>	f = 1MHz	-	13	-	
Total Gate Charge	$Q_g$	V <sub>CE</sub> = 300V	-	32	-	
Gate - Emitter Charge	$Q_{ge}$	I <sub>C</sub> = 15A	-	8	-	nC
Gate - Collector Charge	$Q_{gc}$	V <sub>GE</sub> = 15V	-	11	-	
Turn - on Delay Time	t <sub>d(on)</sub>	I <sub>C</sub> = 15A, V <sub>CC</sub> = 400V	-	18	-	
Rise Time	t <sub>r</sub>	V <sub>GE</sub> = 15V, R <sub>G</sub> = 10Ω	-	20	-	ns
Turn - off Delay Time	$t_{d(off)}$	T <sub>j</sub> = 25°C	-	64	-	
Fall Time	t <sub>f</sub>	Inductive Load	-	75	-	
Turn - on Delay Time	t <sub>d(on)</sub>	I <sub>C</sub> = 15A, V <sub>CC</sub> = 400V	-	18	-	
Rise Time	t <sub>r</sub>	V <sub>GE</sub> = 15V, R <sub>G</sub> = 10Ω	-	22	-	
Turn - off Delay Time	$t_{d(off)}$	T <sub>j</sub> = 175°C	-	74	-	ns
Fall Time	t <sub>f</sub>	Inductive Load	-	130	-	
		I <sub>C</sub> = 45A, V <sub>CC</sub> = 520V			-	
Reverse Bias Safe Operating Area	RBSOA	V <sub>P</sub> = 650V, V <sub>GE</sub> = 15V	FU	LL SQUA	ARE	-
		R <sub>G</sub> = 50Ω, T <sub>j</sub> = 175°C				
		$V_{CC} \leq 360V$				
Short Circuit Withstand Time	t <sub>sc</sub>	V <sub>GE</sub> = 15V	5	-	-	μs
		T <sub>j</sub> = 25°C				

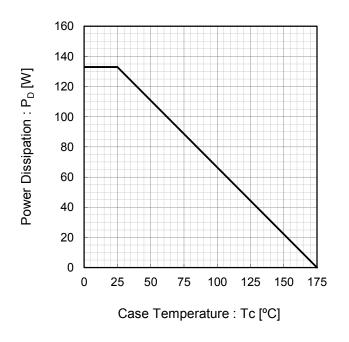
3/11

## •FRD Electrical Characteristics (at $T_j = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Conditions	Values			Linit
			Min.	Тур.	Max.	Unit
Diode Forward Voltage	V <sub>F</sub>	I <sub>F</sub> = 15A T <sub>j</sub> = 25°C T <sub>j</sub> = 175°C	-	1.5 1.3	1.95 -	V
Diode Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 15A V <sub>CC</sub> = 400V di <sub>F</sub> /dt = 200A/µs T <sub>j</sub> = 25°C	-	55	-	ns
Diode Peak Reverse Recovery Current	I <sub>rr</sub>		-	6.0	-	А
Diode Reverse Recovery Charge	Q <sub>rr</sub>		-	0.19	-	μC
Diode Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 15A V <sub>CC</sub> = 400V di <sub>F</sub> /dt = 200A/µs T <sub>j</sub> = 175°C	-	141	-	ns
Diode Peak Reverse Recovery Current	I <sub>rr</sub>		-	9.5	-	А
Diode Reverse Recovery Charge	Q <sub>rr</sub>		-	0.79	-	μC

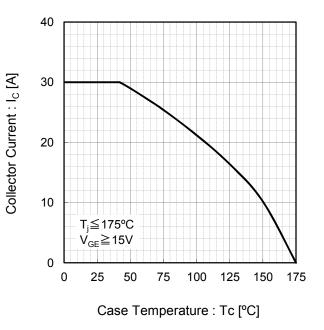
4/11





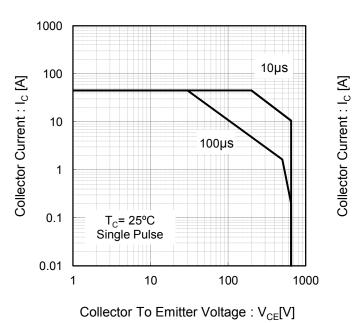
#### Fig.1 Power Dissipation vs. Case Temperature

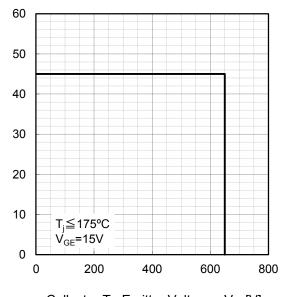
Fig.2 Collector Current vs. Case Temperature



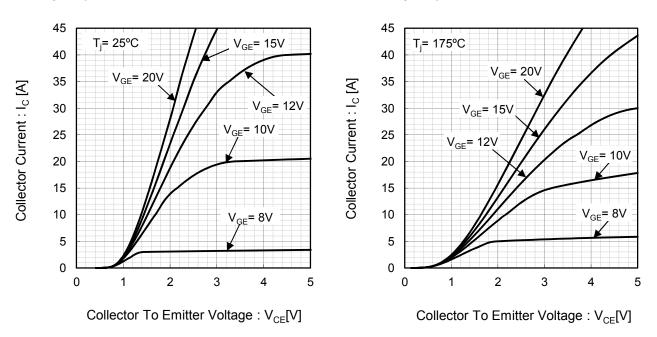
#### Fig.3 Forward Bias Safe Operating Area

Fig.4 Reverse Bias Safe Operating Area





Collector To Emitter Voltage :  $V_{CE}[V]$ 



#### Fig.5 Typical Output Characteristics

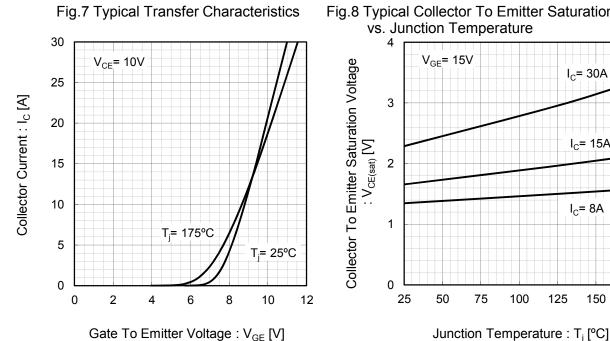


Fig.8 Typical Collector To Emitter Saturation Voltage vs. Junction Temperature

Fig.6 Typical Output Characteristics



I<sub>C</sub>= 30A

 $I_{c} = 15A$ 

I<sub>C</sub>= 8A

150

175

125

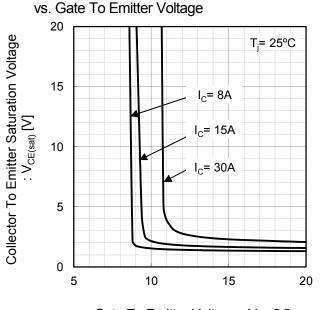


Fig.9 Typical Collector To Emitter Saturation Voltage

Gate To Emitter Voltage :  $V_{GE}$  [V]

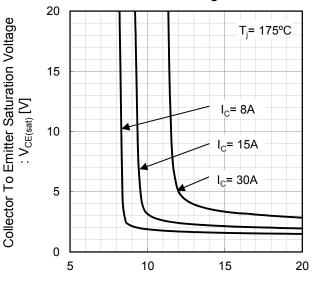
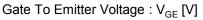
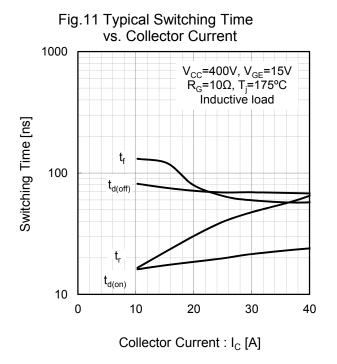
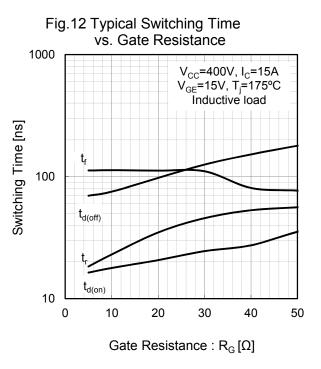
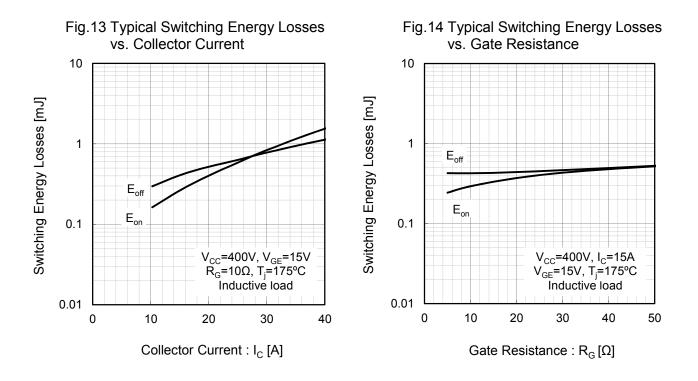


Fig.10 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage









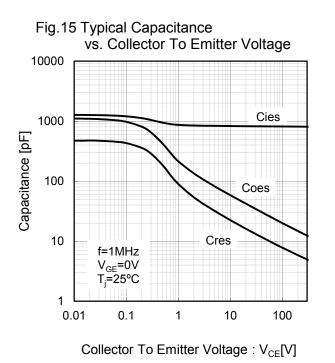
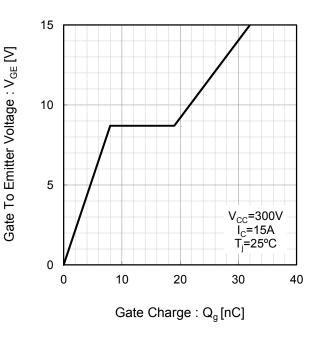


Fig.16 Typical Gate Charge



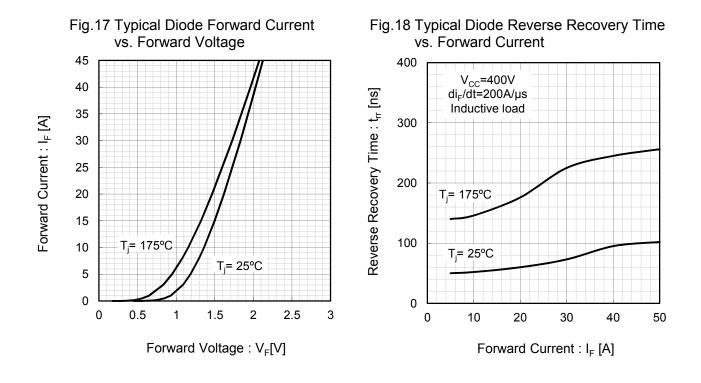


Fig.19 Typical Diode Reverse Recovery Current vs. Forward Current

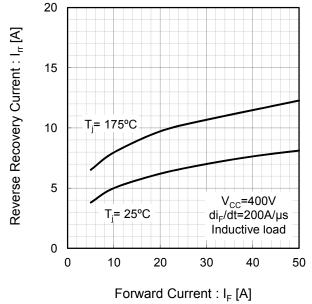
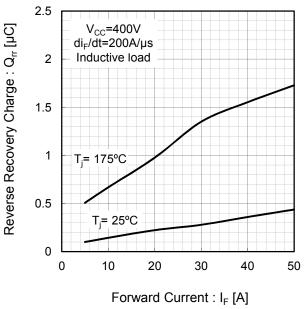


Fig.20 Typical Diode Reverse Recovery Charge vs. Forward Current



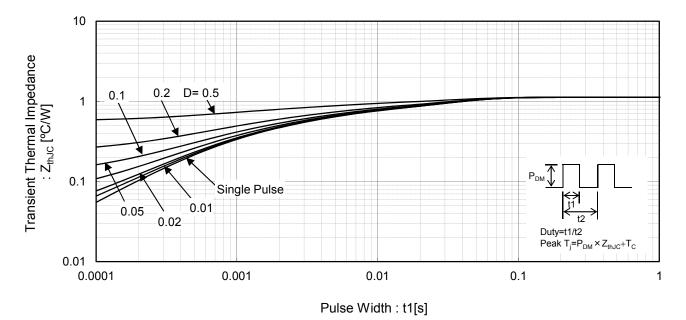


Fig.21 IGBT Transient Thermal Impedance



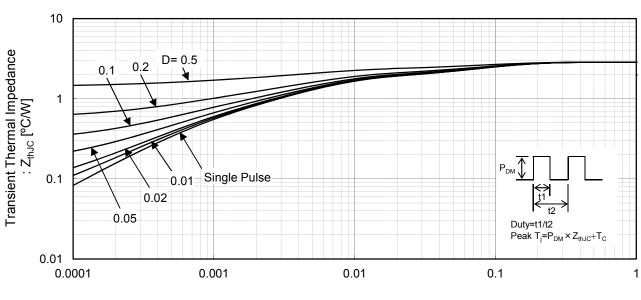


Fig.22 Diode Transient Thermal Impedance

Pulse Width : t1[s]

#### ●Inductive Load Switching Circuit and Waveform

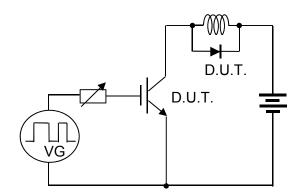


Fig.23 Inductive Load Circuit

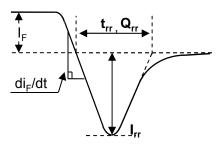


Fig.25 Diode Reverce Recovery Waveform

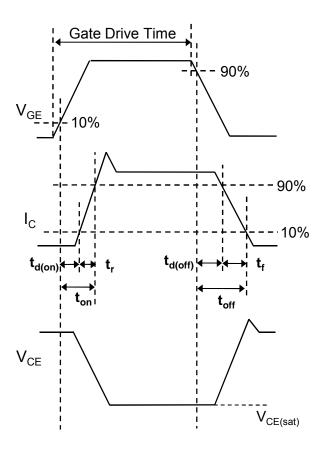


Fig.24 Inductive Load Waveform

	Notes
1)	The information contained herein is subject to change without notice.
2)	Before you use our Products, please contact our sales representative and verify the latest specifica- tions :
3)	Although ROHM is continuously working to improve product reliability and quality, semicon- ductors can break down and malfunction due to various factors. Therefore, in order to prevent personal injury or fire arising from failure, please take safety measures such as complying with the derating characteristics, implementing redundant and fire prevention designs, and utilizing backups and fail-safe procedures. ROHM shall have no responsibility for any damages arising out of the use of our Poducts beyond the rating specified by ROHM.
4)	Examples of application circuits, circuit constants and any other information contained herein are provided only to illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.
5)	The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM or any other parties. ROHM shall have no responsibility whatsoever for any dispute arising out of the use of such technical information.
6)	The Products are intended for use in general electronic equipment (i.e. AV/OA devices, communi- cation, consumer systems, gaming/entertainment sets) as well as the applications indicated in this document.
7)	The Products specified in this document are not designed to be radiation tolerant.
8)	For use of our Products in applications requiring a high degree of reliability (as exemplified below), please contact and consult with a ROHM representative : transportation equipment (i.e. cars, ships, trains), primary communication equipment, traffic lights, fire/crime prevention, safety equipment, medical systems, servers, solar cells, and power transmission systems.
9)	Do not use our Products in applications requiring extremely high reliability, such as aerospace equipment, nuclear power control systems, and submarine repeaters.
10)	ROHM shall have no responsibility for any damages or injury arising from non-compliance with the recommended usage conditions and specifications contained herein.
11)	ROHM has used reasonable care to ensur the accuracy of the information contained in this document. However, ROHM does not warrants that such information is error-free, and ROHM shall have no responsibility for any damages arising from any inaccuracy or misprint of such information.
12)	Please use the Products in accordance with any applicable environmental laws and regulations, such as the RoHS Directive. For more details, including RoHS compatibility, please contact a ROHM sales office. ROHM shall have no responsibility for any damages or losses resulting non-compliance with any applicable laws or regulations.
13)	When providing our Products and technologies contained in this document to other countries, you must abide by the procedures and provisions stipulated in all applicable export laws and regulations, including without limitation the US Export Administration Regulations and the Foreign Exchange and Foreign Trade Act.
14)	This document, in part or in whole, may not be reprinted or reproduced without prior consent of ROHM.



Thank you for your accessing to ROHM product informations. More detail product informations and catalogs are available, please contact us.

### ROHM Customer Support System

http://www.rohm.com/contact/

# **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

ROHM Semiconductor: RGT30NL65DGTL